

# SAMSUNG

## Electro-Mechanics

—  
January 2021

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**P a r t 1**



# Introduction

# SEMCO Contacts

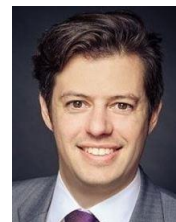


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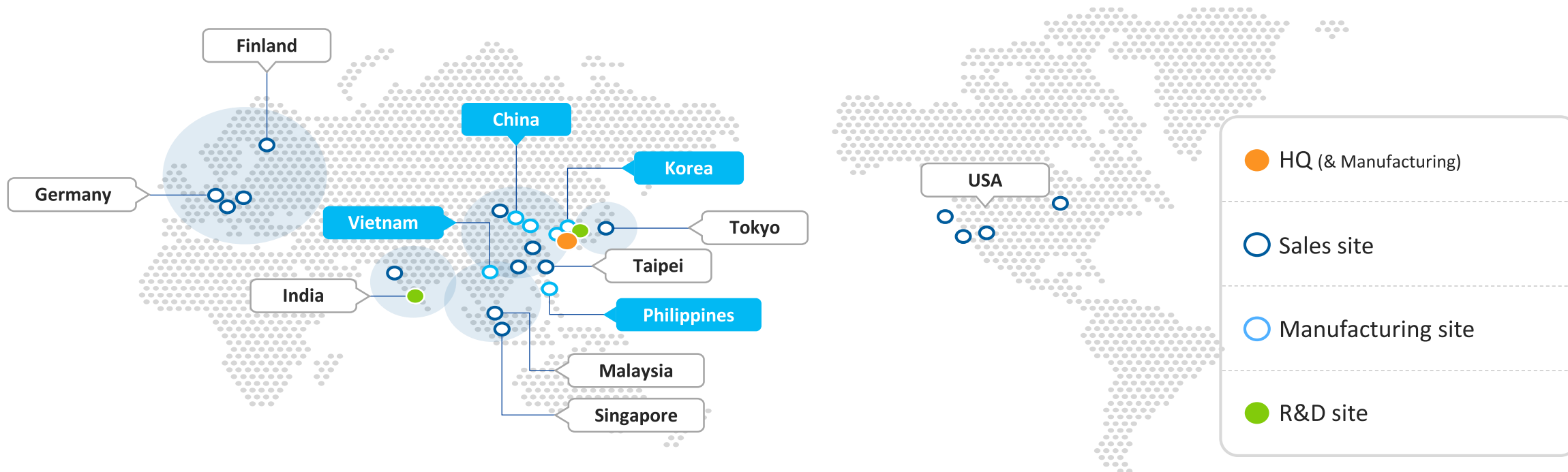
*Quality Topics @ Rutronik and AE for S/P and direct customers*

# Company Overview

## SEMCO

contributes to the advancement of the electronics industry

Foundation	HQ	Global	Employees	Revenue
1973	Suwon Korea	16 sales sites 7 manufacturing sites	36,000 [2020]	\$7.5B [2020]

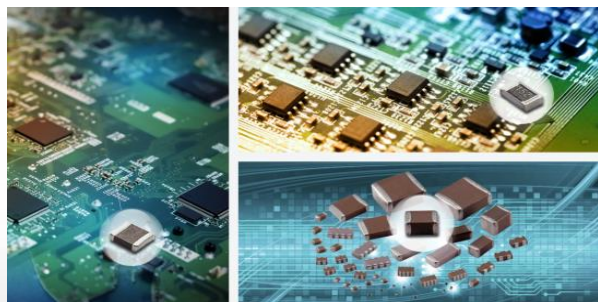


# SEMCO Products

[ Division ]

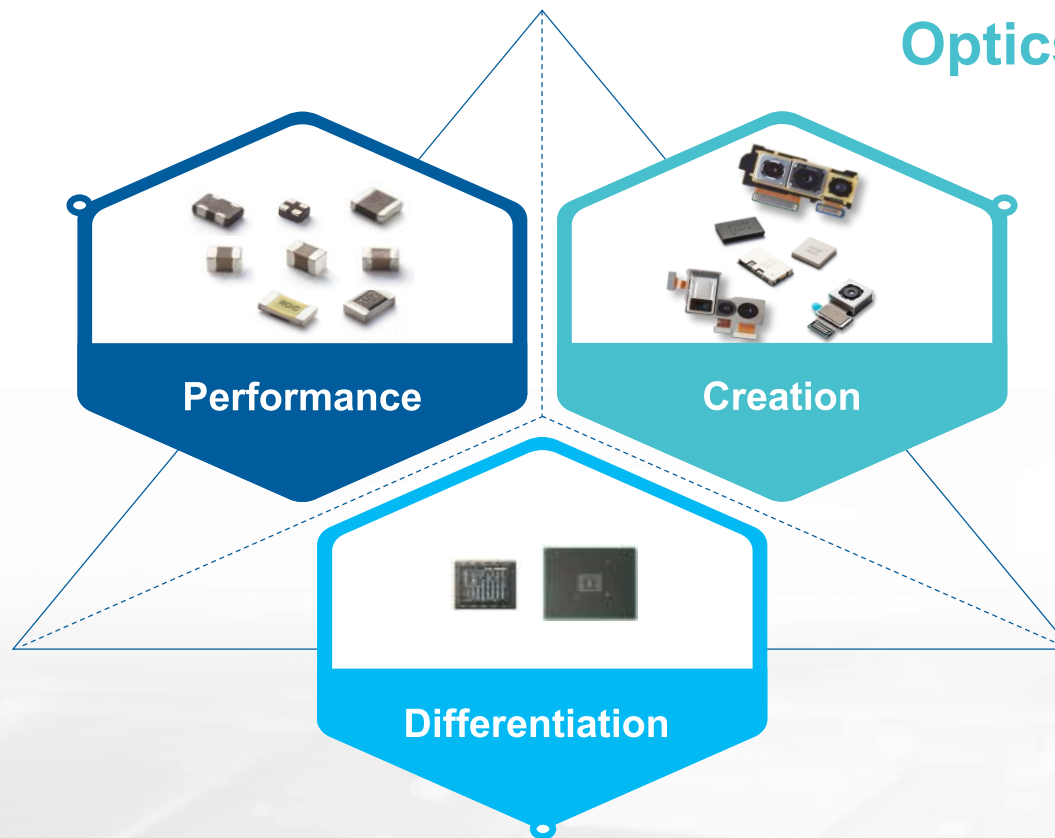
## Component Solution

- MLCC
- Inductor
- Chip Resistor
- Tantalum Capacitor



## Optics & Communication Solution

- Camera Module
  - Lens/Actuator
- Communication Module
  - Sub-6 FEM/mmW Ant/Keyless



## Package Solution

- BGA
- FCBGA



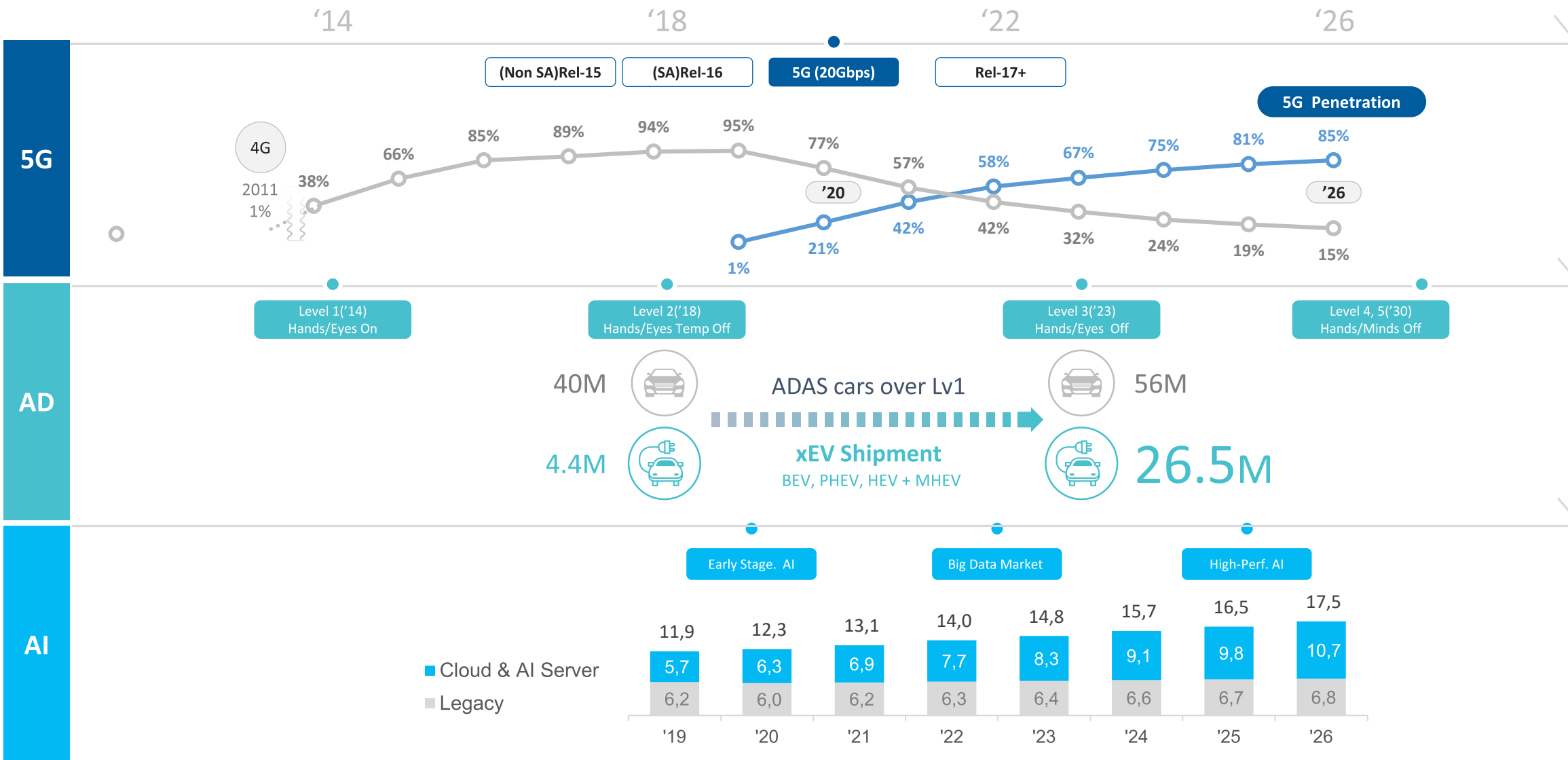


**P a r t 2**

# Market Trends



# Paradigm Shifting to 4<sup>th</sup> Industrial Revolution





# Automotive Snapshot - Megatrends

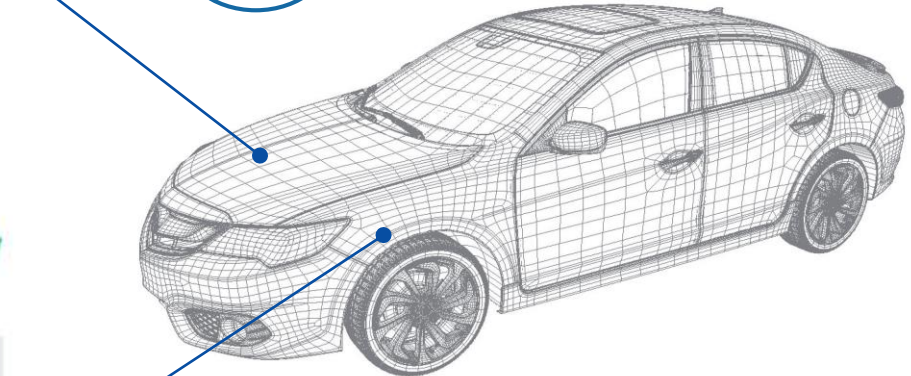
## ACU

(Autonomous Control Unit)

## ADAS

## Sensors

8



## Inverter

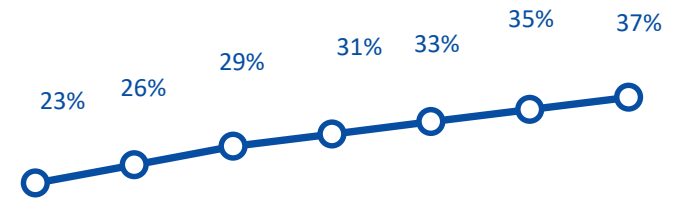
(Main Motor Driver)

## EV

1

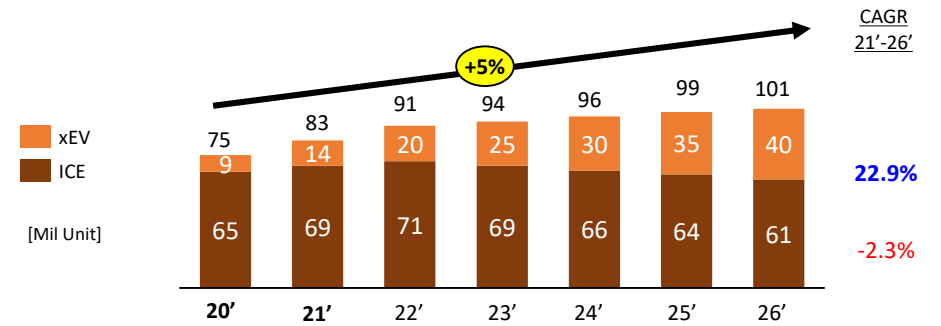


### ADAS LV 2~4 penetration ratio



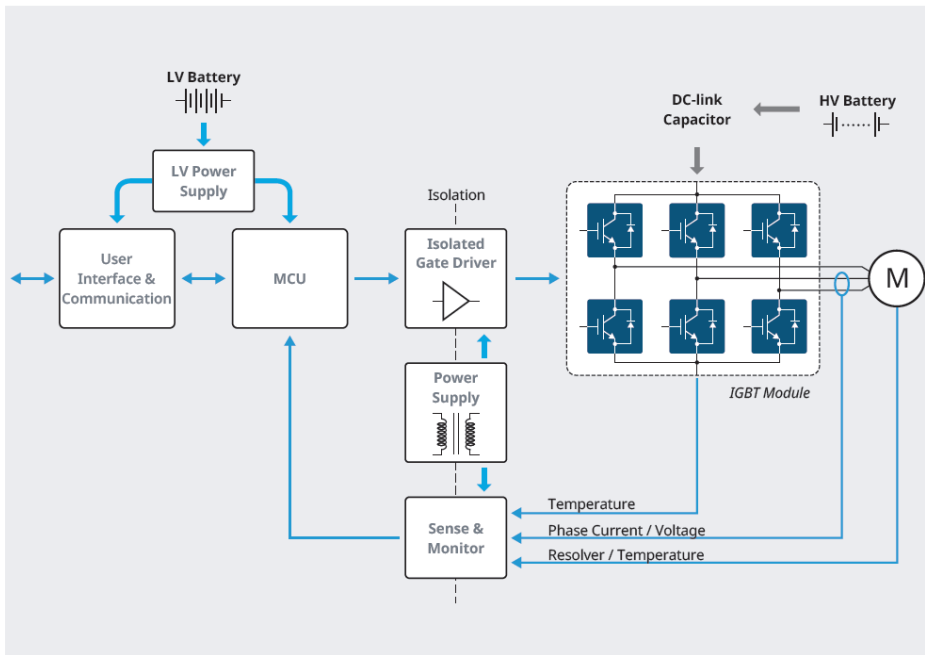
Source : IHS Jul. 2020

### Electrification



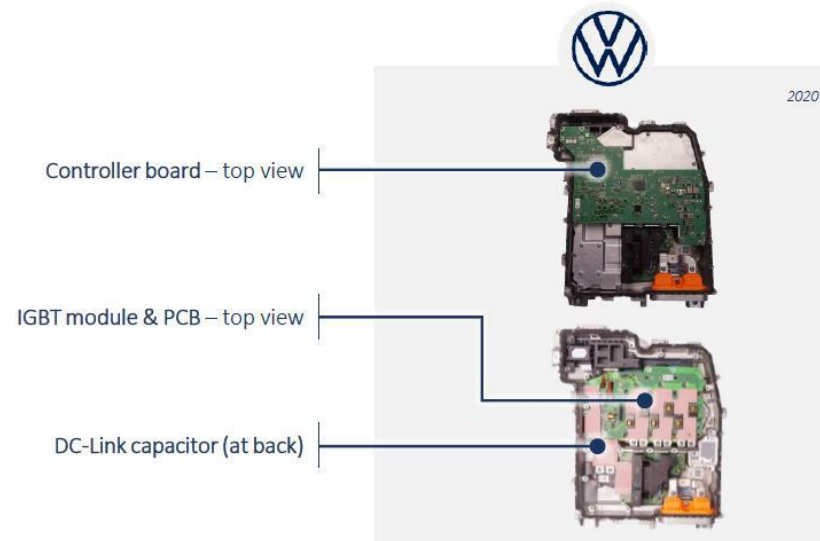
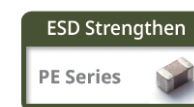
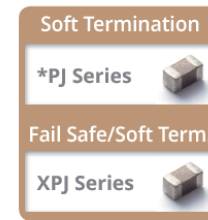
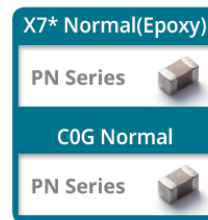
\* EV includes, Battery, Plug in Hybrid, Hybrid and Fuel Cell

# Electrification Snapshot - Main Inverter



## BOM characteristics | New MLCC content per vehicle

- ✓ Up 1000 Automotive grade MLCC required
- ✓ Voltages 16V~100V and higher | Cases sizes 0603~1210i | Capacitance 1pF~22uF

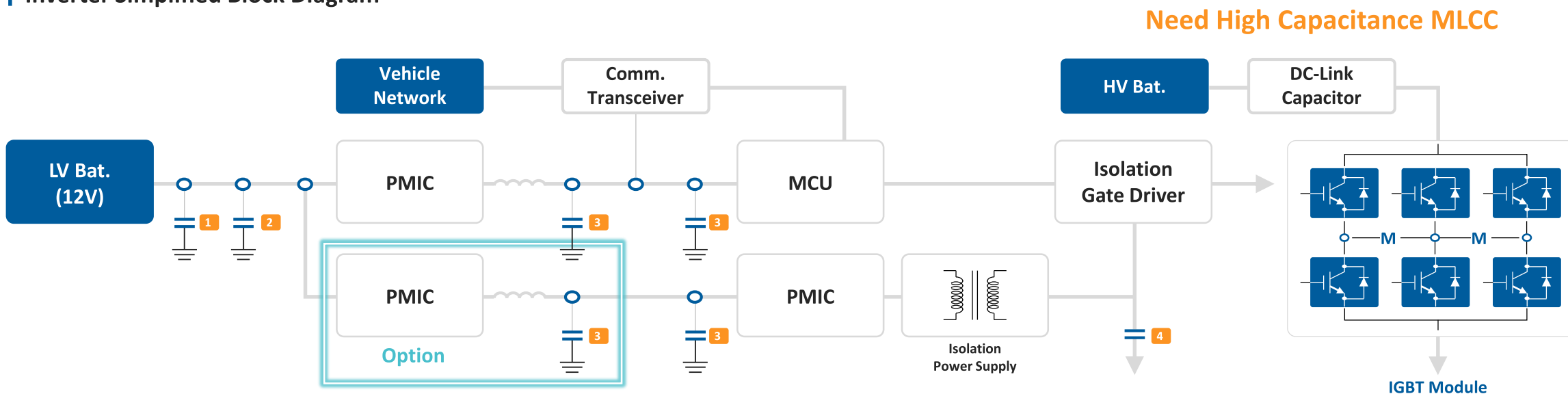


# Case Study

[ Motor Inverter ]

Stabilize the power line of 12V / PMIC blocks → Total capacitance per set ↑

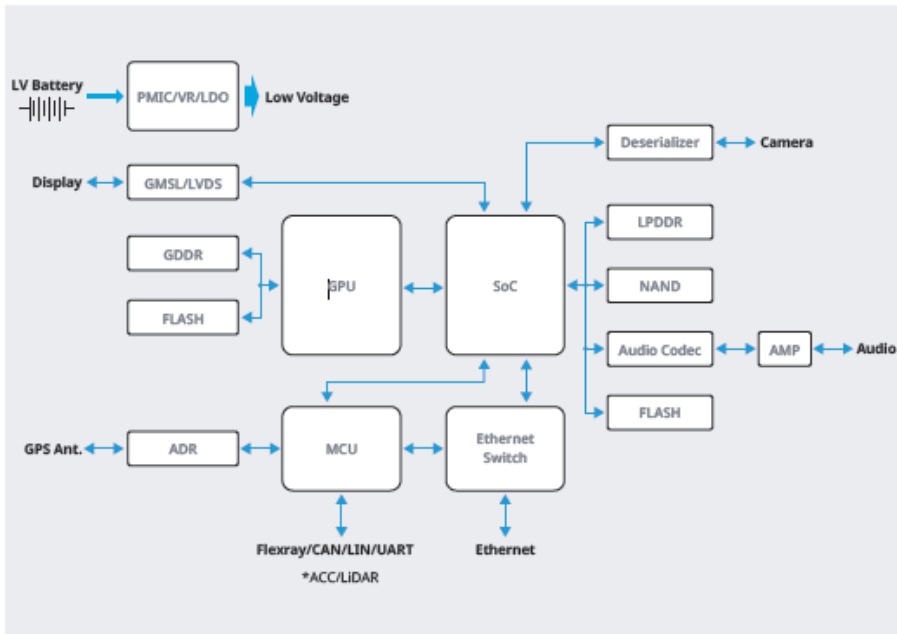
## Inverter Simplified Block Diagram



\* Notice : Each company may have different circuit designs

Item	No	VApply [V]	PN		Temp	C [uF]	VRating	Size [Inch]	Remark
MLCC	1	12	CL21B104KCFXPJ		X7R	0.1	100	0805	Fail Safe/Soft Term.
	2	12	CL32Y475KCIVPJ	CL31Y225KCHVPJ	X7S	4.7 / 2.2	100 / 100	1210 / 1206	High-C, Soft Term.
			CL31Y106KBKVPJ	CL21Y475KBKVPJ	X7S	10 / 4.7	50 / 50	1206 / 0805	High-C, Soft Term.
	3	≤5	CL32Y476MPVVPN	CL10Y225KP8VPN	X7S	47 / 2.2	10 / 10	1210 / 0603	High-C, Soft Term.
	4	10~15	CL32Y226KAVVPN	CL21Y475KABVPN	X7S	22 / 4.7	25 / 25	1210 / 0805	High-C, Soft Term.
			CL31Y106KBKVPJ	CL21Y475KBKVPJ	X7S	10 / 4.7	50 / 50	1206 / 0805	High-C, Soft Term.

# ADAS Snapshot - Autonomous Control Units



## BOM characteristics | High computing power

- ✓ Fail-Safe requirements to address mission critical applications
- ✓ Cases sizes 0603~1210i | Higher Capacitance ~47uF | Voltages 4V~50V

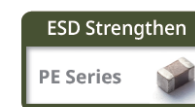
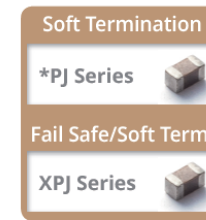
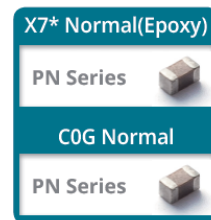


Figure 96: ICAS1 ADAS computer, supplied by Continental

TOP VIEW



BOTTOM VIEW



1 Dual-core ADAS microcontroller

2 Transistor

3 Further Pre-processors

4 Exemplary: Thermal paste (for cooling of the microcontrollers)

5 Can-Bus

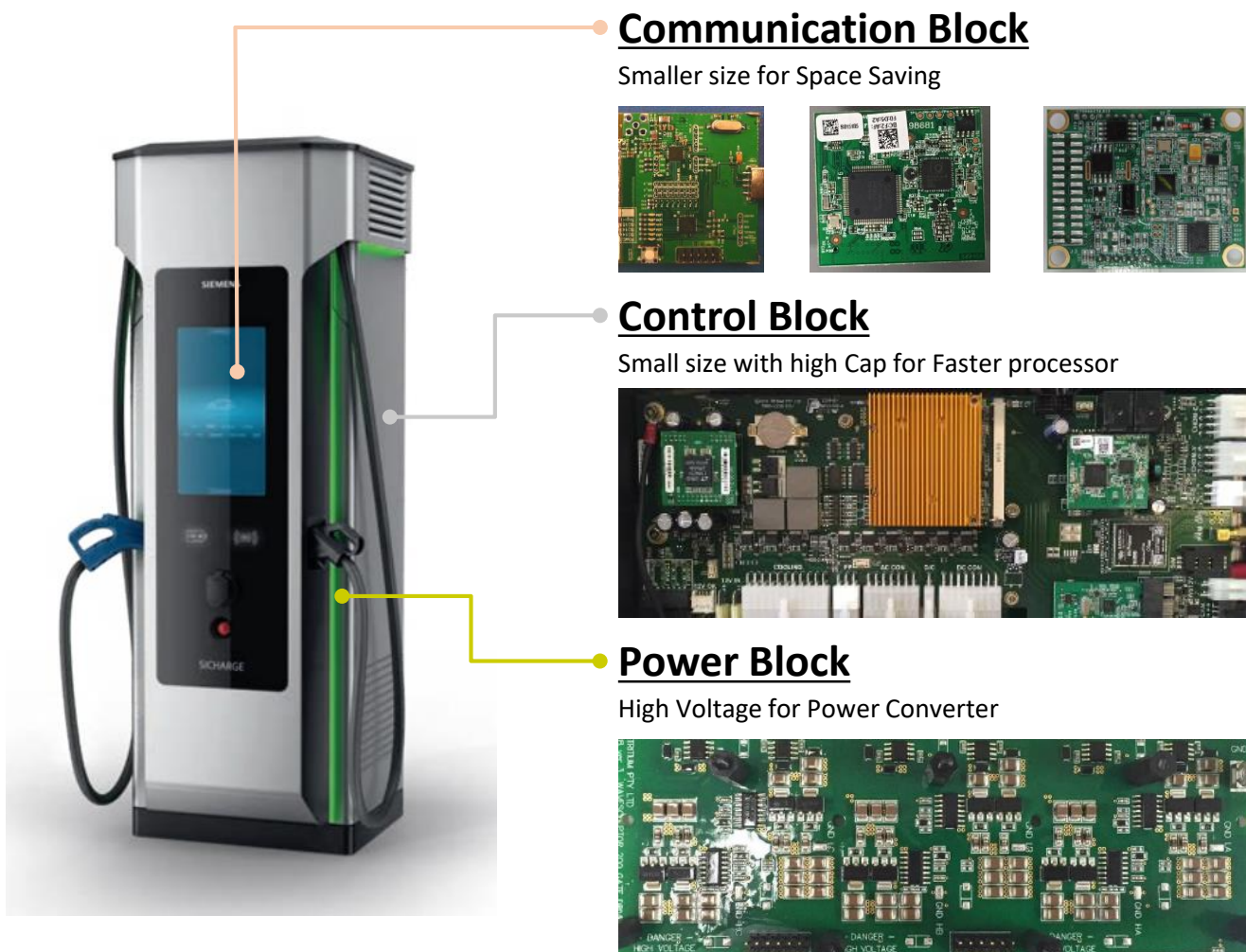
6 Ethernet interface

Source: P3, UBS Evidence Lab

# Product Proposal - EV Charger

[ Industrial MLCC ]

## Smaller size, Higher Cap value with High Temperature for Faster Charging



Size	Rated Volt	100nF	220nF	470nF	1uF
01005	2.5V			X7T (21.Q4)	
0201	6.3V				X7T (21.Q4)
	10V	X7R			
0402	6.3V				X7R
	25V		X7R		

Size	Rated Volt	100nF	1uF	2.2uF	10uF
0805	100V	X7R			
1206	100V			X7R	
	630V	10nF			
1210	630V	47nF			
	1kV	22mF			



**P a r t 3**



# Product Proposal

# Product Proposal

## SEMCO provides higher reliability MLCC for better performance

CL    21    Y    105    K    C    F    V    P    J    E  
 (1)    (2)    (3)    (4)    (5)    (6)    (7)    (8)    (9)    (10)    (11)

Reliability Test Item	General		Automotive	
	Consumer (NN)	High Level I (NW)	AEC-Q200 (PN)	AEC-Q200 + 5mm (PJ)
Application Example *1	Smartphone, TV, PC STB, Game, DSC Consumer Power (Lighting, Adapter) Wireless Modem	Server, Network (Switch, Router) Industrial Power Test Equipment Medical (Class 1~2)	Automotive Heavy Industry Solar PV	Automotive Constant High Power
Biased Humidity	40°C 95% RH 1Vr, 500hr	65°C 90% RH 1Vr, 500hr	85°C 85%RH 1Vr, 1000hr	85°C 85% RH 1Vr, 1000hr
High temp load test	Max temp, 1.0Vr,1000hr	Max temp, *2 1.5Vr, 1000hr	Max temp, *2 1.5Vr, 1000hr	Max temp, *2 1.5Vr, 1000hr
Board Flex	1mm	*3 1mm	3mm	5mm

\*1 Application Guide can be changed by customer test condition or agreement

\*2 The part marked 'derating' is less than 150% of rated voltage in the durability and operational life test

\*3 Perform 2mm bending outgoing test



# Footprint in Automotive MLCC Technology

Size	1 uF	4.7 uF	10 uF	22 uF	47uF	100 uF
0402i (1005m)						
0603i (1608m)	Commodity Products		SEMCO Fine Powder Technology With Vertical Integration			
0805i (2012m)						
1210i (3225m)						

7 Suppliers

4 Suppliers

3 Suppliers

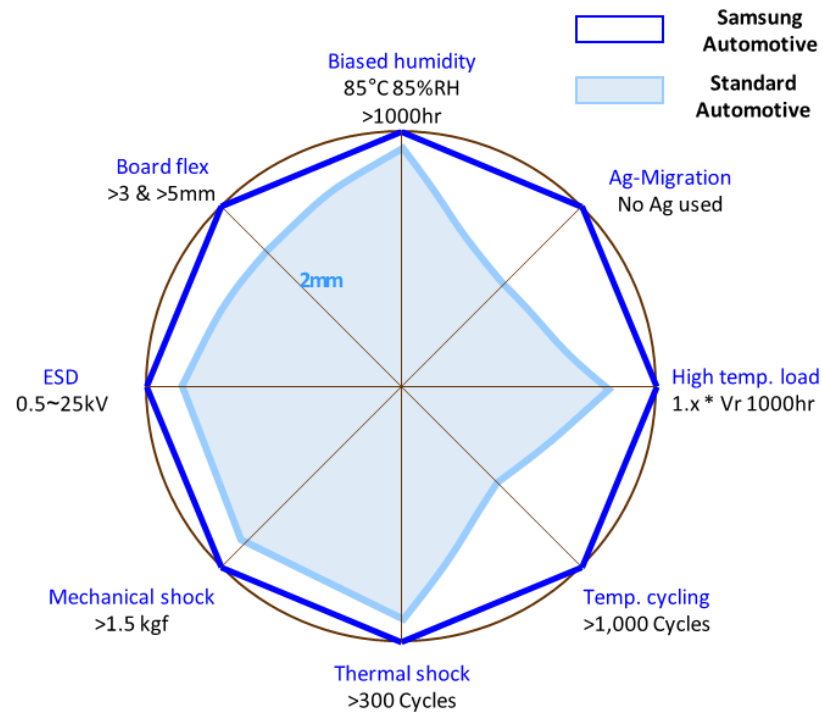
70% of New Designs  
Industry Wide

☑ High Capacitance and Reliability for leading Technologies



Learn more!

- ☑ Extension of MLCC Manufacturing Capacity
- ☑ Investment in Technology and Innovation





# Product Proposal

[ Fail-Safety I Open/Series ]

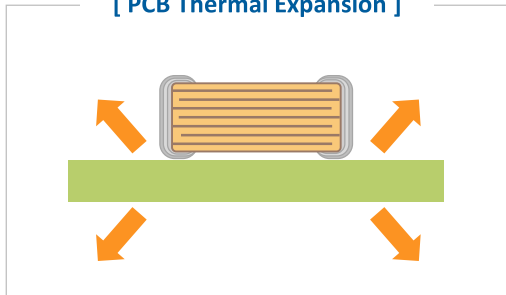
## Fail-safe function with Flex Termination, Open & Series Structure design

### Needs

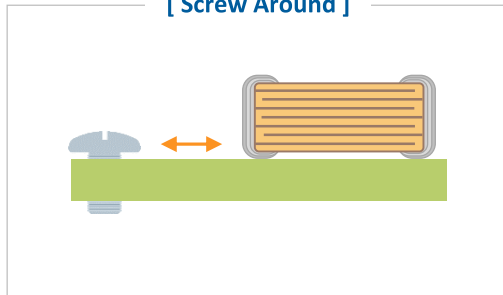
- ✓ Design of Circuit Protection against MLCC  
Crack → Need to High Reliability of Automotive

#### Cause of Damage in MLCC

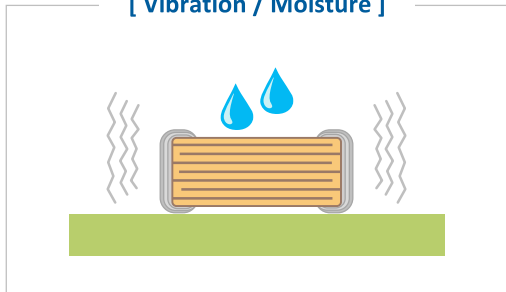
[ PCB Thermal Expansion ]



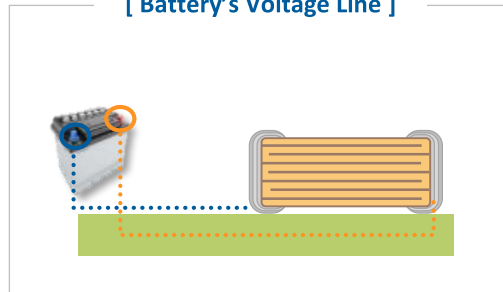
[ Screw Around ]



[ Vibration / Moisture ]

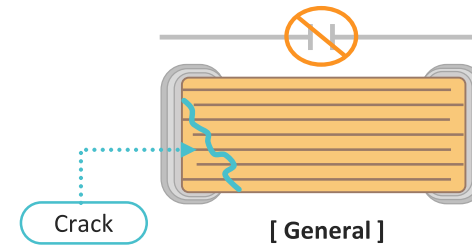


[ Battery's Voltage Line ]

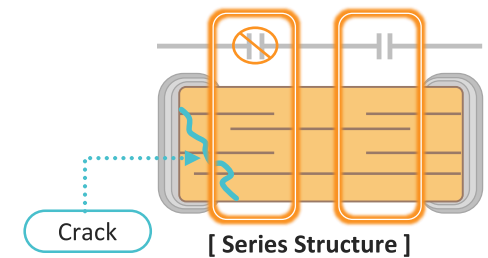
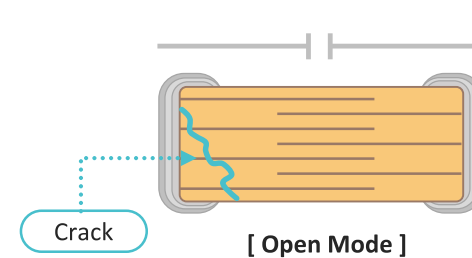


### Value

- ✓ Fail-safe function with open & series structure



Conventional MLCCs has Short in Active Area When internal Crack Occurs



When MLCC Internal Cracks occur,  
the Active Area is not short

Securing High Reliability with  
Short Prevention Design Structure

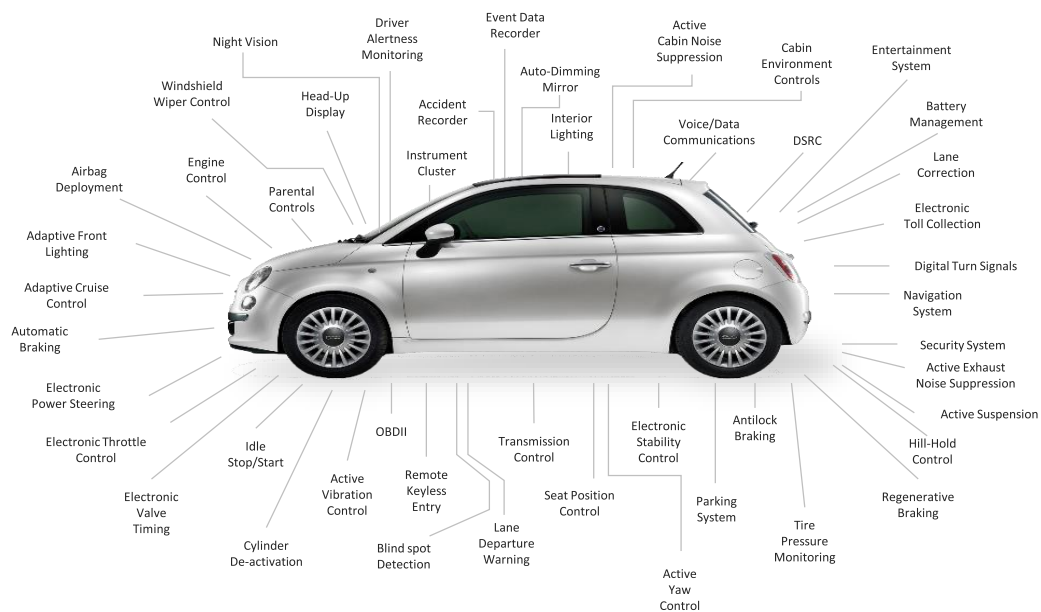
# Product Proposal

[ ESD Protection MLCC ]

## Reduce Circuit Damage by applying ESD Protection MLCC

### Needs

ESD risk increases Increase of Electronic Part Ratio of Automotive

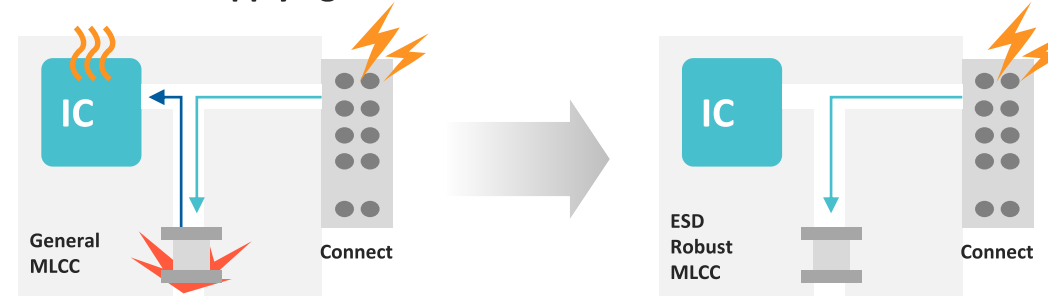


Need to Improve ESD due to increased ECUs

### Value

Reduce Circuit Damage compared to General

Location of Applying ESD Protection MLCC



ESD Protection MLCC Rating

Higher ESD Characteristics than General MLCC by 1.5~2 times

Test Method	Product	Capacitance(nF)		
		2.2	4.7	10
SEMCO Mode1 150pF,330Ω	General	-	10kV	15kV
	ESD Protection MLCC	20kV	20kV	22kV

\* Guaranteed IEC 61000-4-2 Standard

# SEMCO Automotive MLCC Part Number

<u>CL</u> Series	<u>31</u> Size	<u>B</u> Diel.	<u>224</u> Cap.	<u>K</u> Tol.	<u>H</u> Volt.	<u>8</u> Thick.	<u>W</u> Design	<u>P</u> Product	<u>N</u> Grade	<u>C</u> Packaging
	03=0201"	C=COG	2	B=±0.1pF	R=4V	5=0.5mm	<i>Please see below</i>			C=Cardboard, Tape, 7"Reel
	05=0406"	B=X7R	significant digits	<b>C=±0.25pF</b>	Q=6.3V	8=0.8mm				D=Cardboard, Tape, 13"Reel
	10=0603"	Y=X7S	+	D=±0.5pF	P=10V	C=0.85mm				E=Embossed Type, 7" Reel
	21=0805"	Z=X7T	number of zeros	F=±1pF or ±1%	O=16V	P=1.15mm				F=Embossed Type, 13"Reel
	31=1206"	E=X8L	use "R" denotes decimal point	G=±2%	A=25V	F=1.25mm				
	32=1210"	G=X8G		<b>J=±5%</b> <b>K=±10%</b> <b>M=±20%</b>	B=50V C=100V E=250V H=630V I=1KV J=2KV	H=1.6mm I=2.0mm J=2.5mm				

## Design

Internal Design	Outer Termination	
	Cu	Metal-Epoxy
<b>Normal</b>	<b>1</b>	<b>V</b> <b>4</b>
<b>Open</b>		<b>W</b> <b>5</b>
<b>Series</b>		<b>X</b>

## Product

**P** = Automotive Qualified  
(Based on AEC-Q200)

## Grade

**N** = Normal  
**J** = 5mm bending Strength  
**E** = ESD Protection

# Line-up

Size	Voltage	<10p	<100p	100p	220p	470p	1n	2.2n	4.7n	10n	22n	47n	100n	220n	470n	1μ	2.2μ	4.7μ	10μ	22μ	47μ	100μ	220μ	Voltage	
1210"	100V																X7R	X7S						100V	
	50V																		X7S						50V
	25V																			X7S					25V
	16V																				X7R				16V
	6.3V																					X7R	'22		6.3V
	4V																						X7T	'23	
1206"	100V															X7R	X7S	'23							100V
	50V																	X7R	X7S						50V
	25V																		X7R						25V
	16V																			X7R					16V
	10V																				X7R				10V
	6.3V																					X7R	X7T		6.3V
4V																						X7T		4V	
0805"	100V									COG						X7S	'22								100V
	50V																X7R	X7S	'22						50V
	25V																			X7S					25V
	16V																				X7S				16V
	6.3V																					'22			6.3V
0603"	100V									COG			X7R												100V
	50V															X7R									50V
	25V																				'22				25V
	16V																								16V
	10V																								10V
6.3V																						'22		6.3V	
0402"	100V									COG															100V
	50V																								50V
	25V																								25V
	16V																						'22		16V
	10V																								10V
	6.3V																								6.3V
0201"	25V																								25V
	16V																								16V
	6.3V																								6.3V
Size	Voltage	<10p	47p	100p	220p	470p	1n	2.2n	4.7n	10n	22n	47n	100n	220n	470n	1μ	2.2μ	4.7μ	10μ	22μ	47μ	100μ	220μ	Voltage	

## Automotive

### COG

- 5% tolerance is standard
- 50V & 100V are most used
- E6 is recommended

1 | 1.5 | 2.2 | 3.3 | 4.7 | 6.8

### X7R | X7S | X7T

- 10% tolerance is standard
- 6.3V | 16V | 50V | 100V in focus
- E3 is recommended

1 | 2.2 | 4.7

R&D

Recommended

Smaller / Higher V available

NRND

# High Voltage Automotive Roadmap 2021.Q4

SAMSUNG

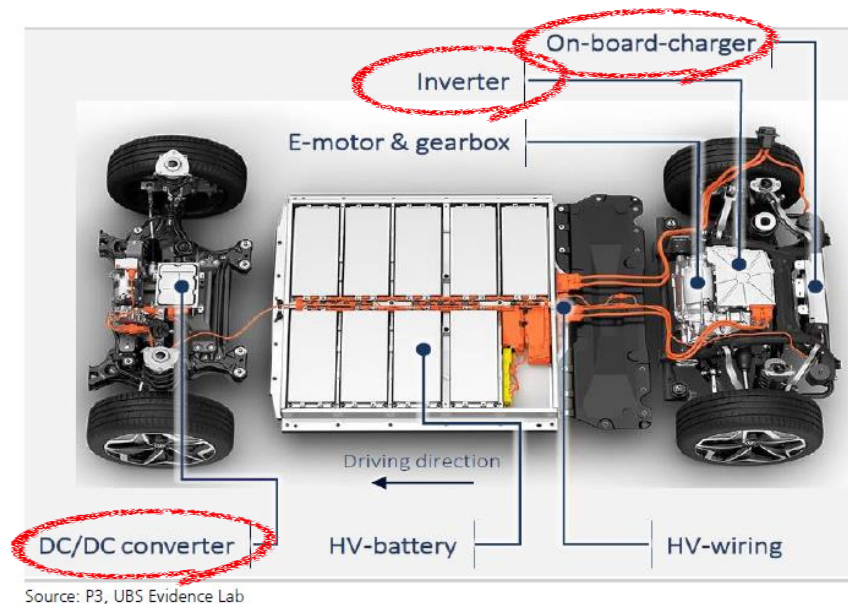
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R&D

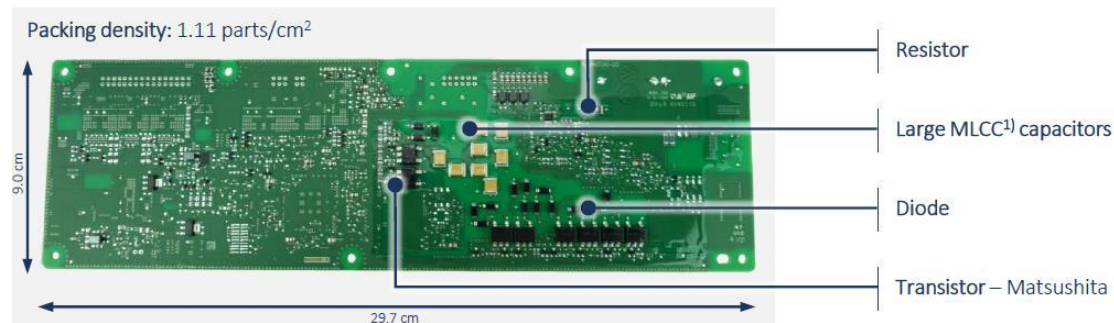
MP Ready

Size / inch	Rated Voltage (V)	Capacitance / nF							
		1	2.2	4.7	10	22	47	100	220
1206"	250				MP Ready	MP Ready	MP Ready	MP Ready	R&D
	630	MP Ready	MP Ready	MP Ready	MP Ready	R&D	R&D		
	1000	MP Ready	MP Ready	R&D	R&D				
1210"	630			R&D	R&D	R&D	R&D	R&D	
	1000					R&D			

## Targeted Applications



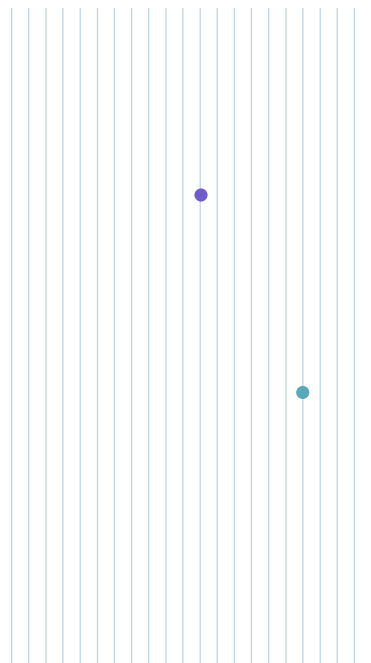
## Examples





# Part 4

## Summary & Discussion

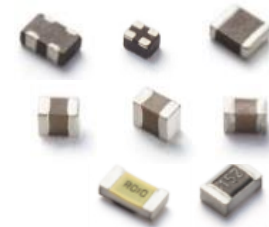
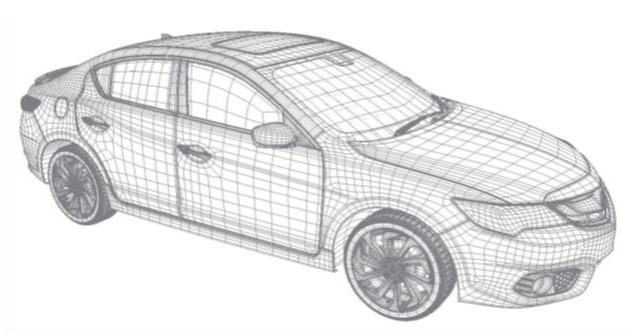


# Let us build our future mobility together

## Great Components for Superb Driving

Rutronik

SEMCO



# THANK YOU

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